# 74AHC1G4214-Q100

## 14-stage divider and oscillator

Rev. 3 — 3 October 2023

Product data sheet

### 1. General description

74AHC1G4214-Q100 is a 14-stage divider and oscillator. It consists of a chain of 14 flip-flops. Each flip-flop divides the frequency of the previous flip-flop by two, consequently the 74AHC1G4214-Q100 counts up to 2<sup>14</sup> = 16384. The single inverting stage (X1 to X2) functions as a crystal oscillator or an input buffer for an external oscillator. When used as a buffer the output X2 should be left floating. The frequency of the output (Q) is the frequency applied to X1 divided by 16384. The divider advances on the negative-going transition of X1.

The X1 input is overvoltage tolerant. This feature allows the use of this device as a voltage level translator in mixed voltage environments.

This product has been qualified to the Automotive Electronics Council (AEC) standard Q100 (Grade 1) and is suitable for use in automotive applications.

#### 2. Features and benefits

- Automotive product qualification in accordance with AEC-Q100 (Grade 1)
  - Specified from -40 °C to +85 °C and from -40 °C to +125 °C
- Wide supply voltage range from 2.0 V to 5.5 V
- Overvoltage tolerant inputs to 5.5 V
- High noise immunity
- CMOS low power dissipation
- Latch-up performance exceeds 100 mA per JESD 78 Class II
- ESD protection:
  - HBM: ANSI/ESDA/JEDEC JS-001 class 2 exceeds 2000 V
  - CDM: ANSI/ESDA/JEDEC JS-002 class C3 exceeds 1000 V

## 3. Ordering information

#### **Table 1. Ordering information**

Type number	Package						
	Temperature range	Name	Description	Version			
74AHC1G4214GW-Q100	-40 °C to +125 °C		plastic thin shrink small outline package; 5 leads; body width 1.25 mm	SOT353-1			

### 4. Marking

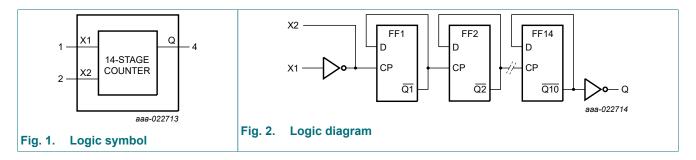
#### Table 2. Marking codes

Type number	Marking[1]
74AHC1G4214GW-Q100	C4

[1] The pin 1 indicator is located on the lower left corner of the device, below the marking code.

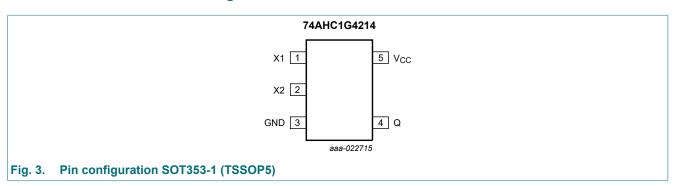


## 5. Functional diagram



## 6. Pinning information

#### 6.1. Pinning

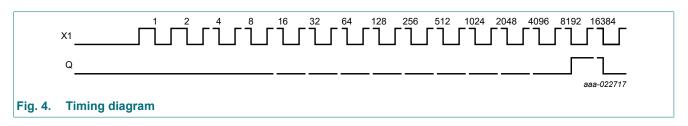


### 6.2. Pin description

Table 3. Pin description

Symbol	Pin	Description
X1	1	clock input/oscillator pin
X2	2	oscillator pin
GND	3	ground (0 V)
Q	4	divider output
V <sub>CC</sub>	5	supply voltage

### 7. Functional description



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## 8. Limiting values

#### **Table 4. Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CC</sub>	supply voltage		-0.5	+7.0	V
VI	input voltage		-0.5	+7.0	V
I <sub>IK</sub>	input clamping current	V <sub>I</sub> < -0.5 V	-20	-	mA
I <sub>OK</sub>	output clamping current	$V_O < -0.5 \text{ V or } V_O > V_{CC} + 0.5 \text{ V}$ [1]	-	±20	mA
Io	output current	$-0.5 \text{ V} < \text{V}_{\text{O}} < \text{V}_{\text{CC}} + 0.5 \text{ V}$	-	±25	mA
I <sub>CC</sub>	supply current		-	75	mA
$I_{GND}$	ground current		-75	-	mA
T <sub>stg</sub>	storage temperature		-65	+150	°C
P <sub>tot</sub>	total power dissipation	$T_{amb} = -40  ^{\circ}\text{C to } +125  ^{\circ}\text{C}$ [2]	-	250	mW

<sup>[1]</sup> The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

## 9. Recommended operating conditions

#### Table 5. Recommended operating conditions

Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V <sub>CC</sub>	supply voltage		2.0	5.0	5.5	V
VI	input voltage		0	-	5.5	V
Vo	output voltage		0	-	V <sub>CC</sub>	V
T <sub>amb</sub>	ambient temperature		-40	+25	+125	°C
Δt/ΔV	input transition rise and fall	V <sub>CC</sub> = 3.3 V ± 0.3 V	-	-	100	ns/V
	rate	V <sub>CC</sub> = 5.0 V ± 0.5 V	-	-	20	ns/V

<sup>[2]</sup> For SOT353-1 (TSSOP5) package: P<sub>tot</sub> derates linearly with 3.3 mW/K above 74 °C.

## 10. Static characteristics

#### **Table 6. Static characteristics**

Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		25 °C		-40 °C	to +85 °C	-40 °C to +125 °C		Unit
			Min	Тур	Max	Min	Max	Min	Max	
V <sub>IH</sub>	HIGH-level	X1								
	input voltage	V <sub>CC</sub> = 2.0 V	1.7	-	-	1.7	-	1.7	-	V
		V <sub>CC</sub> = 3.0 V	2.4	-	-	2.4	-	2.4	-	V
		V <sub>CC</sub> = 5.5 V	4.4	-	-	4.4	-	4.4	-	V
V <sub>IL</sub>	LOW-level	X1								
	input voltage	V <sub>CC</sub> = 2.0 V	-	-	0.3	-	0.3	-	0.3	V
		V <sub>CC</sub> = 3.0 V	-	-	0.6	-	0.6	-	0.6	V
		V <sub>CC</sub> = 5.5 V	-	-	1.1	-	1.1	-	1.1	V
V <sub>OH</sub>	HIGH-level	Q; $V_I = V_{IH}$ or $V_{IL}$								
	output voltage	I <sub>O</sub> = -50 μA; V <sub>CC</sub> = 2.0 V	1.9	2.0	-	1.9	-	1.9	-	V
		I <sub>O</sub> = -50 μA; V <sub>CC</sub> = 3.0 V	2.9	3.0	-	2.9	-	2.9	-	V
		I <sub>O</sub> = -50 μA; V <sub>CC</sub> = 4.5 V	4.4	4.5	-	4.4	-	4.4	-	V
		$I_{O}$ = -4.0 mA; $V_{CC}$ = 3.0 V	2.58	-	-	2.48	-	2.40	-	V
		$I_{O}$ = -8.0 mA; $V_{CC}$ = 4.5 V	3.94	-	-	3.8	-	3.70	-	V
		$X2; V_I = V_{IH} \text{ or } V_{IL}$								
		I <sub>O</sub> = -50 μA; V <sub>CC</sub> = 2.0 V	1.9	2.0	-	1.9	-	1.9	-	V
		I <sub>O</sub> = -50 μA; V <sub>CC</sub> = 3.0 V	2.9	3.0	-	2.9	-	2.9	-	V
		I <sub>O</sub> = -50 μA; V <sub>CC</sub> = 4.5 V	4.4	4.5	-	4.4	-	4.4	-	V
		$I_O = -2.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.58	-	-	2.48	-	2.40	-	V
		$I_{O}$ = -3.0 mA; $V_{CC}$ = 4.5 V	3.94	-	-	3.8	-	3.70	-	V
V <sub>OL</sub>	LOW-level	Q; V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>								
	output voltage	I <sub>O</sub> = 50 μA; V <sub>CC</sub> = 2.0 V	-	0	0.1	-	0.1	-	0.1	V
		I <sub>O</sub> = 50 μA; V <sub>CC</sub> = 3.0 V	-	0	0.1	-	0.1	-	0.1	V
		I <sub>O</sub> = 50 μA; V <sub>CC</sub> = 4.5 V	-	0	0.1	-	0.1	-	0.1	V
		$I_O = 4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.36	-	0.44	-	0.55	V
		$I_{O}$ = 8.0 mA; $V_{CC}$ = 4.5 V	-	-	0.36	-	0.44	-	0.55	V
		$X2; V_I = V_{IH} \text{ or } V_{IL}$								
		I <sub>O</sub> = 50 μA; V <sub>CC</sub> = 2.0 V	-	0	0.1	-	0.1	-	0.1	V
		$I_O = 50 \mu A; V_{CC} = 3.0 V$	-	0	0.1	-	0.1	-	0.1	V
		I <sub>O</sub> = 50 μA; V <sub>CC</sub> = 4.5 V	-	0	0.1	-	0.1	-	0.1	V
		$I_{O}$ = 2.0 mA; $V_{CC}$ = 3.0 V	-	-	0.36	-	0.44	-	0.55	V
		$I_O = 3.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	-	-	0.36	-	0.44	-	0.55	V
l <sub>l</sub>	input leakage current	X1; V <sub>I</sub> = 5.5 V or GND; V <sub>CC</sub> = 0 V to 5.5 V	-	-	0.1	-	1.0	-	2.0	μA
I <sub>CC</sub>	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 5.5 \text{ V}$	-	-	1.0	-	10	-	40	μΑ
Cı	input capacitance	X1	-	3	8	-	8	-	8	pF

## 11. Dynamic characteristics

#### **Table 7. Dynamic characteristics**

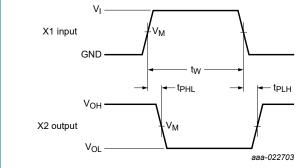
GND = 0 V;  $t_r = t_f = \le 3.0$  ns. For test circuit see Fig. 7. For waveforms see Fig. 5 and Fig. 6.

Symbol	Parameter	Conditions			25 °C		-40 °C	to +85 °C	-40 °C to +125 °C		Unit
				Min	Тур	Max	Min	Max	Min	Max	1
t <sub>pd</sub>	propagation	X1 to X2	[1]								
	delay	V <sub>CC</sub> = 3.0 V to 3.6 V	[2]								
		C <sub>L</sub> = 15 pF		-	3	7	1	11	1	13	ns
		C <sub>L</sub> = 50 pF		-	7	13	1	16	1	18	ns
		V <sub>CC</sub> = 4.5 V to 5.5 V	[3]								
		C <sub>L</sub> = 15 pF		-	2	5	1	7	1	9	ns
		C <sub>L</sub> = 50 pF		-	6	10	1	11	1	12	ns
		X1 to Q	[1]								
		V <sub>CC</sub> = 3.0 V to 3.6 V	[2]								
		C <sub>L</sub> = 15 pF		-	33	55	1	67	1	78	ns
		C <sub>L</sub> = 50 pF		-	35	60	1	71	1	82	ns
		V <sub>CC</sub> = 4.5 V to 5.5 V	[3]								
		C <sub>L</sub> = 15 pF		-	23	36	1	44	1	52	ns
		C <sub>L</sub> = 50 pF		-	25	40	1	51	1	58	ns
t <sub>W</sub>	pulse width	X1 HIGH or LOW									
		V <sub>CC</sub> = 3.0 V to 3.6 V		4	-	-	5	-	7	-	ns
		V <sub>CC</sub> = 4.5 V to 5.5 V		3	-	-	4	-	5	-	ns
f <sub>max</sub>	maximum	X1									
	frequency	V <sub>CC</sub> = 3.3 V		125	-	-	100	-	70	-	MHz
		V <sub>CC</sub> = 5 V		165	-	-	125	-	100	-	MHz
C <sub>PD</sub>	power dissipation	$C_L$ = 50 pF; $f_i$ = 1 MHz; $V_I$ = GND to $V_{CC}$	[4]								
	capacitance	V <sub>CC</sub> = 3.3 V		-	4	-	-	-	-	-	pF
		V <sub>CC</sub> = 5 V		-	5	-	-	-	-	-	рF

 $f_i$  = input frequency in MHz;  $C_L$  = output load capacitance in pF;  $V_{CC}$  = supply voltage in Volt.

 $t_{pd}$  is the same as  $t_{PLH}$  and  $t_{PHL}$ . Typical values are measured at  $V_{CC}$  = 3.3 V. Typical values are measured at  $V_{CC}$  = 5.0 V.  $C_{PD}$  is used to determine the dynamic power dissipation  $P_D$  (µW).  $P_D$  =  $C_{PD}$  x  $V_{CC}$   $^2$  x  $f_i$  +  $C_L$  x  $V_{CC}$   $^2$  x  $f_i$  / 16384 where:

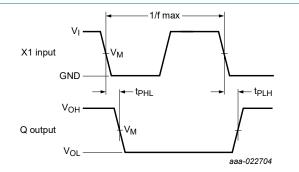
#### 11.1. Waveforms and test circuit



Measurement points are given in <u>Table 8</u>.

 $V_{OL}$  and  $V_{OH}$  are typical output voltage levels that occur with the output load.

Fig. 5. Input X1 to output X2 propagation delay times



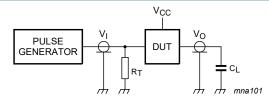
Measurement points are given in <u>Table 8</u>.

 $V_{OL}$  and  $V_{OH}$  are typical output voltage levels that occur with the output load.

Fig. 6. Input X1 to output Q propagation delay times

#### **Table 8. Measurement points**

Inputs	Output	
V <sub>I</sub>	V <sub>M</sub>	V <sub>M</sub>
GND to V <sub>CC</sub>	0.5 x V <sub>CC</sub>	0.5 x V <sub>CC</sub>



Test data is given in <u>Table 7</u>. Definitions for test circuit:

C<sub>L</sub> = Load capacitance including jig and probe capacitance.

 $R_T$  = Termination resistance should be equal to output impedance  $Z_o$  of the pulse generator.

Fig. 7. Test circuit for measuring switching times

### 12. Crystal oscillator

#### 12.1. Typical crystal oscillator circuit

A typical crystal oscillator schematic is shown in Fig. 8. R1 is the power limiting resistor, its value depends on the frequency and required stability against changes in  $V_{CC}$  or average  $I_{CC}$ . For starting and maintaining oscillation a minimum transconductance is necessary, so R1 should not be too large. A practical value for R1 is 2.2 k $\Omega$ .

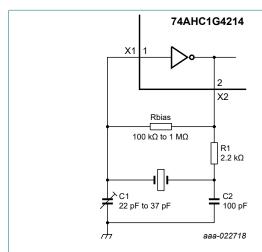


Fig. 8. External component connection for a crystal oscillator

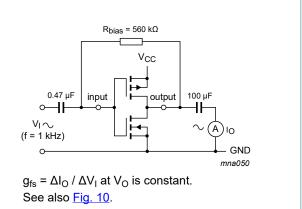
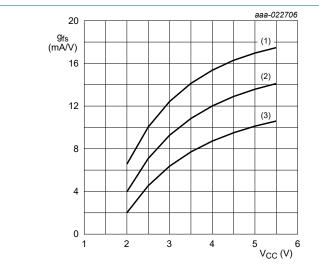


Fig. 9. Test set-up for measuring forward transconductance



 $T_{amb}$  = 25 °C.

- (1) Maximum.
- (2) Typical.
- (3) Minimum.

Fig. 10. Typical forward transconductance as function of the supply voltage

## 13. Package outline

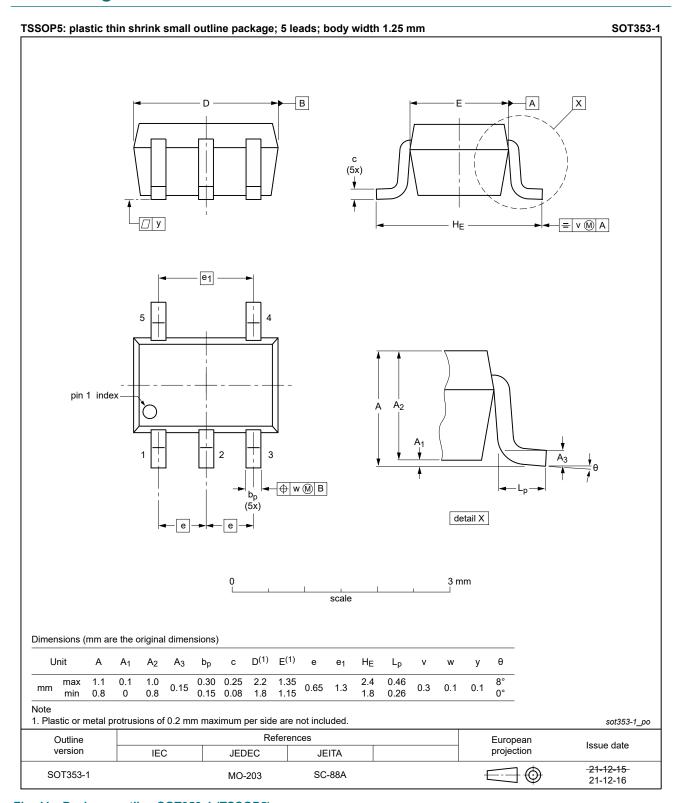


Fig. 11. Package outline SOT353-1 (TSSOP5)

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### 14. Abbreviations

#### **Table 9. Abbreviations**

Acronym	Description
CDM	Charged Device Model
CMOS	Complementary Metal-Oxide Semiconductor
DUT	Device Under Test
ESD	ElectroStatic Discharge
HBM	Human Body Model

## 15. Revision history

#### Table 10. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes			
74AHC1G4214_Q100 v.3	20231003	Product data sheet	-	74AHC1G4214_Q100 v.2			
Modifications:	Section 2: E	Section 2: ESD specification updated according to the latest JEDEC standard.					
74AHC1G4214_Q100 v.2	20220113	Product data sheet	-	74AHC1G4214_Q100 v.1			
Modifications:		Section 8: Derating values for P <sub>tot</sub> total power dissipation updated.  Fig. 11: Package outline drawing SOT353-1 (TSSOP5) updated.					
74AHC1G4214_Q100 v.1	20190208	Product data sheet	-	-			

### 16. Legal information

#### **Data sheet status**

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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Product [short] data sheet	Production	This document contains the product specification.

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